

**Company :**  
**Company Name :**  
**Nature Of Business :**  
**Designation :**

**Qualcomm India Pvt Ltd**  
**Qualcomm India Pvt Ltd**  
**Semi Conductor**  
**Sr. Engineer- Modem System Engineer**

Tentative Job Location :
Hyderabad

|                          |   |
|--------------------------|---|
| Job Title                | Systems Engineers/Specialist (PHY and MAC Layer)  |
| Company - Division       | <a href="#">Qualcomm Technologies, Inc. – Qualcomm CDMA Technologies (OCT) and Qualcomm Research India</a>  |
| Job Area                 | Engineering - Systems   |
| Location                 | Bangalore and Hyderabad   |
| Educational Requirements | Masters in Electrical Engineering (Communications/Signal Processing areas) Ph.D. in Electrical Engineering (Communications/Signal Processing areas)   |
| Overview                 | <p>Over the past thirty years, the systems engineering team at Qualcomm conceived and commercialized key innovations in wireless communication systems including cdma2000, EV-DO, HSPA, OFDMA based LTE-Advanced, Carrier Aggregation, HetNets, Small Cells, LTE in Unlicensed, LTE Direct, M2M (eMTC, NB-IoT), Wi-Fi 802.11ac and 802.11ax.</p> <p>We are looking for innovative engineers in the areas of wireless communications and signal processing, who develop deep understanding of problems through thoughtful data-driven analysis and then shepherd the solutions through the lab to real world deployment.</p> <p>Individuals in this role will actively participate and contribute to Qualcomm's systems engineering activities related to the evolution of 3G, 4G, 5G, WLAN and satellite communications technologies towards ever improving efficiency and capability. They will be required to gain thorough understanding of 3GPP/3GPP2 physical layer specifications and will be responsible for designing WWAN modem baseband algorithms and subsequent performance characterization, fixed point design and validation. The work would include theoretical analysis, computer aided analysis, regular active participation in design and review sessions, contribution to QUALCOMM's IP portfolio, systems support for implementation, technical contributions towards proprietary or public air interface specifications.</p> |

**Description :**



| Component   |                          |
|---|--------------------------|
| Total Gross Pay                                       | INR 21.60 L              |
| Retirals (PF and Gratuity)                            | INR 1.30 L               |
| Performance Bonus*                                    | INR 0.91 L               |
| Joining Bonus   | INR 9.60 L               |
| Relocation Bonus ( Paid within 60 days )              | INR 0.50 L               |
| Restricted Stock Value Awards (Vesting in 3 years )** | INR 22.50 L ( \$ 30,000) |
| Retention Bonus (Paid after 12 months )               | INR 5.00 L               |

**\*Based on individual & Organization Performance || \*\*RSV -33% vesting every year**

**Additional Benefits : Relocation Assistance , Insurance , Transportation .**

**\$1=INR75**

Amount

**Package  
Details :**

| Component   |                          |
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|  |                |
|--|----------------|
| <b>Bond :</b>                                | <b>False</b>   |
| <b>CPI CutOff :</b>                          | <b>0.0</b>     |
| <b>Medical Requirments :</b>                 | <b>NA</b>      |
| <b>Resume Shortlist :</b>                    | <b>True</b>    |
| <b>Resume Shortlist Criteria:</b>            | <b>N/A</b>     |
| <b>Aptitude Test:</b>                        | <b>True</b>    |
| <b>Aptitude Test Duration:</b>               | <b>45 ins</b>  |
| <b>Group Discussion:</b>                     | <b>False</b>   |
| <b>Technical Test:</b>                       | <b>True</b>    |
| <b>Technical Test Duration:</b>              | <b>45 mins</b> |
| <b>Technical Interview:</b>                  | <b>True</b>    |
| <b>Technical Interview Duration:</b>         | <b>4:00hrs</b> |
| <b>Number of Techincal Interview Rounds:</b> | <b>4</b>       |
| <b>HR Interview:</b>                         | <b>True</b>    |
| <b>HR Interview Duration:</b>                | <b>30 mins</b> |

**Additional  
Information:**